

SSCL095N100GT4

N-Channel Enhancement Mode MOSFET

Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	l _D
100V	$\pm 20 V$	9.5mΩ@10V	90A

Description

This device is N-Channel enhancement MOSFET.

Uses SGT technology and design to provide excellent

RDSON with low gate charge. This device is suitable
for use in DC-DC conversion, power switch and
charging circuit.

100% UIS + ΔVDS + Rg Tested!

Applications

- Load Switch
- PWM Application
- Power Management
- DC-DC Conversion

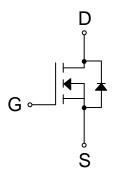
Ordering Information

Device	Package	Shipping
SSCL095N100GT4	TO-220-3L	50/Tube

Pin configuration



TO-220-3L (Top View)



Pin Configuration



Marking

(XXYY: Internal Traceability Code)



➤ Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V_{DSS}	Drain-to-Source Volta	ige	100	V
V_{GSS}	Gate-to-Source Volta	ge	±20	V
	October Decision Comment d	T _C =25℃	90	^
ID	Continuous Drain Current d	T _C =100°C	50	A
	Outline Brain Outline	T _A =25℃	12	^
IDSM	Continuous Drain Current ^a	T _A =70°C	9	A
I _{DM}	Pulsed Drain Curren	t ^b	360	Α
Ь	Danna Diagingtian C	Tc=25℃	125	10/
P_D	Power Dissipation ^c	T _C =100°C	50	W
Б	Danna Diagingtian 2	T _A =25℃	2.5	10/
P _{DSM}	Power Dissipation ^a	T _A =70°C	1.6	W
las	Avalanche Current ^b L=0.5mH \$	Single Pulse	22	Α
Eas	Avalanche Energy ^b L=0.5mH \$	Single Pulse	121	mJ
TJ	Operation junction tempe	erature	-55~150	°C
T _{STG}	Storage temperature ra	ange	-55~150	$^{\circ}$

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance ^a	50	°
R _{θJC}	Junction-to-Case Thermal Resistance	1.0	°C/W

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25 °C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

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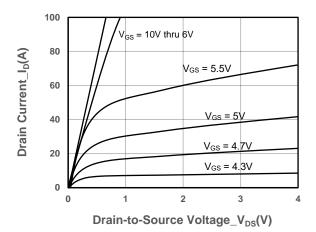
> Electrical Characteristics (T_A=25℃ unless otherwise noted)

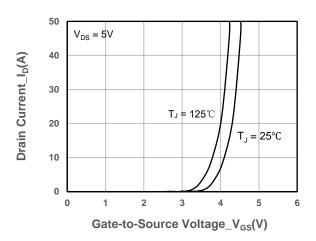
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	100			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250uA$	2	2.8	4	V
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 20A		9.5	12.5	mΩ
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 100V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	Igss	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
Transconductance	GFS	V _{DS} = 5V, I _D = 15A		20		S
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = 20A		0.85	1.3	V
Gate Resistance	R _G	V _{DS} = 0V, f = 1MHz		1.5		Ω
Input Capacitance	Cıss	V - 50V V - 0V		1285		
Output Capacitance	Coss	$V_{DS} = 50V, V_{GS} = 0V,$ f = 1MHz		475		pF
Reverse Transfer Capacitance	C _{RSS}	1 = 1MH2		15		
Total Gate Charge	Q _G	101/1/ 501/		20		
Gate to Source Charge	Q _{GS}	$V_{GS} = 10V, V_{DS} = 50V,$		6		nC
Gate to Drain Charge	Q _{GD}	- I _D = 20A		7.2		
Turn-on Delay Time	T _{D(ON)}			12.5		
Rise Time	Tr	V _{GS} = 10V, V _{DS} = 50V,		34.5]
Turn-off Delay Time	T _{D(OFF)}	$I_D = 20A, R_G = 6\Omega,$		22		ns
Fall Time	T _f			7.2		





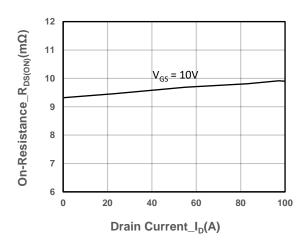
➤ Typical Performance Characteristics (T_A=25°C unless otherwise noted)

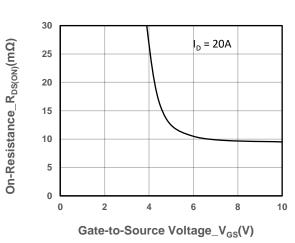




Output Characteristics

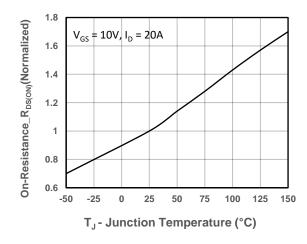
Transfer Characteristics

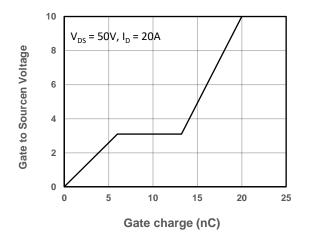




On-Resistance vs. Drain Current and Gate Voltag

On-Resistance vs. Gate-to-Source Voltage



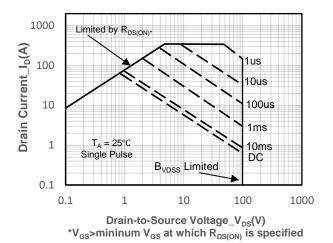


On-Resistance vs. Junction Temperature

Gate-Source Voltage vs. Gate charge

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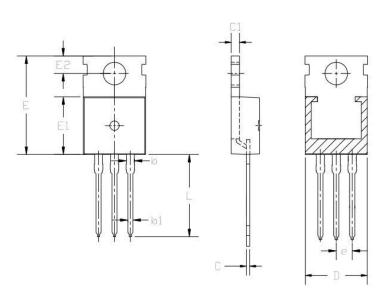




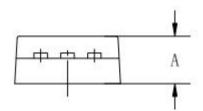
Safe Operating Area vs. Junction-to-Ambient

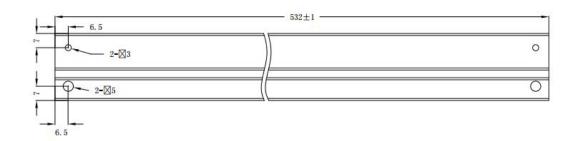


Package Information

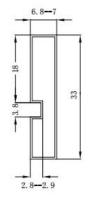


ounmor.	MILLIMETER			
SYMBOL	MIN	NOM	MAX	
Α	4.40		4.60	
lo l	1.20	2555	1.36	
b1	0.70	1222	0.90	
C	0.48		0.53	
01	1.28	00000	1.32	
D	9.80	10.00	10.20	
E	15.20	15,45	15.75	
E1	9.00	9.20	9.40	
E2	2.60	5272	2.90	
е		2.54		
	13.00	252	13,40	





 $T=0.5 \pm 0.1$



- 技术要求:
 1. 材料: 透明PVC
 2. 表面电阻: 10E5~10E10 0HMS/SQ
 3. 未注尺寸公差±0.3
 4. 黑色钉子由厂家出货时塞于左端



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